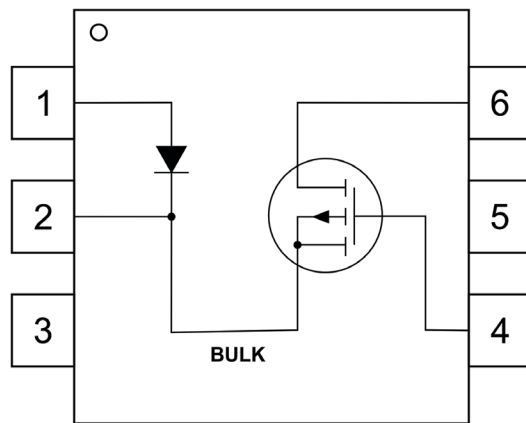


TECHNICAL DATA
VT03
1 μ m RADFET
in 6L SOT-23 Plastic package
For doses between 3mGy (0.3rad) and 10Gy (1krad)
VT03 Description and Pin-Out

The VT03 is Varadis 1 μ m RADFET chip packaged in a plastic SOT-23 six lead package. The part consists of a single RADFET and a diode (see Figure 1 and Table 1). The RADFET's gate oxide thickness is approximately 1 μ m thick and W/L is 300 μ m/50 μ m. The RADFET has individual gate and drain terminals, while the source and bulk are common and connected together; this is also the diode bulk contact.


Table 1: VT03 pin-out description.

Pin Number	Description
1	Diode Anode ¹
2	Source/bulk (common)
3	Not Connected
4	Gate
5	Not Connected
6	Drain

Figure 1: VT03 pin-out drawing.

Maximum Ratings

Maximum ratings of the VT03 RADFET are given in Table 2.

Table 2: Maximum ratings of the VT03. Measured at room temperature.

Characteristics	Symbol	Specification	Unit	Remarks
Drain-Source Voltage	V_{DS}	-25	V	
Gate-Source Voltage	V_{GS}	± 50	V	
Gate-Drain Voltage	V_{GD}	± 50	V	
Drain Current	I_D	-1	mA	Continuous
Source Current	I_S	-1	mA	Continuous
Temperature Endurance Range	T_{ER}	-55 to +125	$^{\circ}C$	
Maximum sensitivity	S_{MAX}	1.35	mV/cGy	

Modes of Operation
Irradiation Mode (Sense Mode)

¹ More information about the purpose of the on-chip diode you can find in the notes section

In this mode of operation, it is recommended that all terminals of the RADFET are connected to ground. For alternative biasing options, contact the manufacturer.

Read-Out Mode (Accumulated Radiation Dose Read-Out)

The RADFET can be read at arbitrary intervals, depending on the application. The period between readings can be from seconds to days or even months. The circuit used to read out the RADFET (Reader Circuit - RC) is shown in Figure 2 with connection configuration in Table 3.

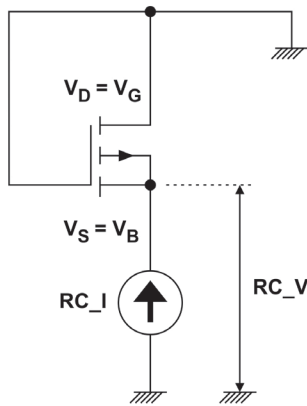


Table 3: Connections in Read-Out mode.

Terminal	Bias
S=B	Current is forced (RC_I) Voltage reading is taken (RC_V)
G=D	0V (common)

Figure 2: Reader Circuit (RC) configuration.

Current RC_I is forced into the RADFET, connected in RC configuration (Figure 2). The voltage at the source (RC_V) is measured; this voltage is called “RC threshold voltage”. Typical I-V curves at different temperatures for un-irradiated device in this configuration are shown in Figure 3. In principle, any read-out current (RC_I) value above $5 \mu\text{A}$ can be chosen, if the value is kept unchanged after the start of radiation exposure. For best temperature compensation, the RC_I value of $12.5 \mu\text{A}$ is recommended where the temperature influence is minimal.

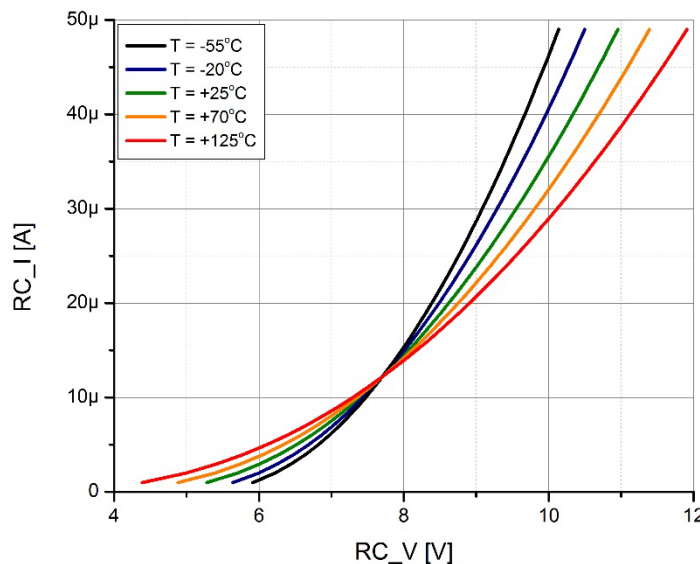


Figure 3: Typical Reader Circuit (RC) I-V curves, pre-irradiation. Measured at different temperatures.

Electrical Parameters

The most important electrical parameter of un-irradiated RADFET is RC threshold voltage (RC_V). Specification for RC_V is given in Table 4. Results of RC_V measurements prior to shipment are included in documentation that comes with ordered parts. Typically, the range of RC_V of delivered parts is significantly tighter than in the specification.

Table 4: Specification for RC threshold voltage. Measured at room temperature.

Parameter	Symbol	Test Circuit and Conditions	Limits		Unit
			Min	Max	
RC Threshold Voltage	RC_V	Figure 2 and Table 3 RC_I = 12.5 μ A	5	9	V

Calibration Data

The calibration curve for the RADFET shows evolution of ΔV (the change in RC threshold voltage with reference to its pre-irradiation value) with dose. Note that a specific calibration curve, obtained using the Co-60 source, is associated with each RADFET production batch. The calibration curve, together with analytical equation and fitting coefficients, will be provided with the supplied parts. For illustration, typical calibration curve is shown in Figure 4.

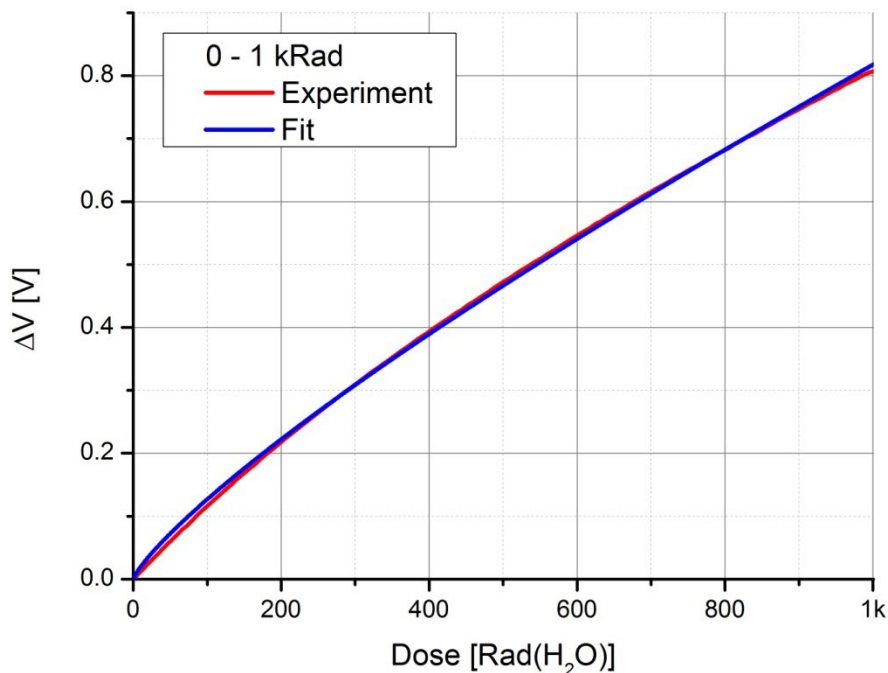


Figure 4: Typical calibration curve indicating change in RC_V during irradiation. Irradiation at room temperature with Co-60 gamma source, dose rate ~30 Gy/h (3 krad/h). All RADFET terminals grounded during irradiation. Measurements at room temperature.

Package Information

VT03 package specifications are given in Table 5, and package diagram in Figure 5.

Table 5: VT03 package specifications.

Description	Specification
Package Type	Six-pin plastic SOT-23 package
Package Dimensions (L x W x H)	2.90 mm x 2.80 mm x 1.10 mm (see Figure 5)

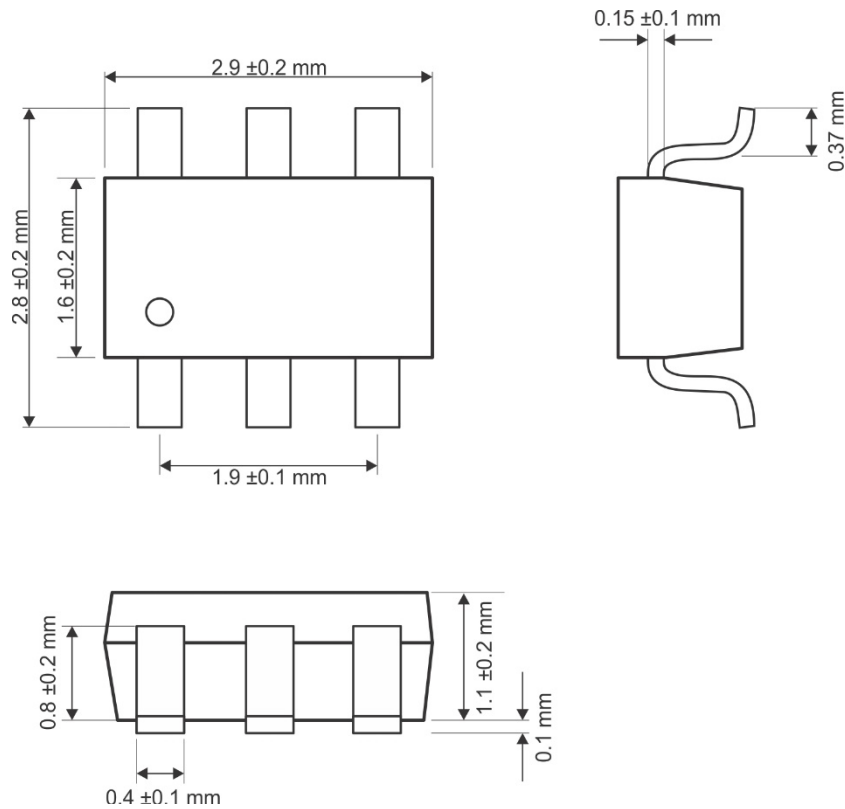


Figure 5: VT03 package diagram.

Recommended dimensions for solder pad layout are given in Figure 6.

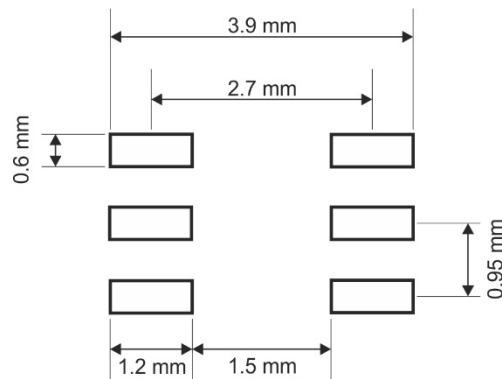


Figure 6: Recommended solder pad layout. Dimensions are inclusive of plating.

It is highly recommended to avoid any metal traces below the component. Any metal or high-density material near the component might influence the radiation response and cause deviations from the supplied calibration parameters.

Handling

Our RADFETs undergo 100% electrical test and visual inspection immediately prior to shipment. Therefore, all parts should reach the customer in excellent condition. To ensure that the RADFETs remain in this condition, please handle the parts as carefully as possible and observe standard precautions related to ESD sensitive devices.

Soldering

For our RADFETs we strongly recommend hand soldering onto printed circuit boards prior to exposure in radiation field. The temperature used in the soldering should be as low as possible using low-temperature melting point solder alloys. It is a good practice to solder the pins individually with 10sec break between pins, this will prevent overheating of the RADFET die and allow the heat generated from the soldering to dissipate.

It is important that the RADFET is the last component to be soldered onto a circuit board. If different soldering method is required, please contact us at support@varadis.com.

Notes

We calibrate our standard VT03 products at room temperature using a Co-60 gamma-ray source. Irradiation is performed in a single event at the dose rate of ~30 Gy/hour (3 krad/hour) and includes the dose range from 0.1–10 Gy (10 rad – 1 krad).

Customers whose requirements include conditions significantly different from the above should contact support@varadis.com to discuss the optimum way to implement the RADFETs for their specific applications.

The VT03 has a large dynamic range, from 3 mGy (0.3 rad) to 10 Gy (1 krad) and beyond (with additional calibration).

While the supplied calibration curve covers doses from 0.1–10 Gy, other measurements at room temperature show that lower doses, down to 3 mGy, can be detected. The lower the minimum dose required by the customer, the more accurate must be the RADFET temperature compensation and read-out electronics. Please contact support@varadis.com for further details if your application includes lower dose range.

Regarding the high end of the dose range, VT03 can measure doses higher than 10 Gy (1 krad). However, the sensitivity decreases with dose and it depends on the actual application requirements whether this sensitivity loss is acceptable. As VT03 comes calibrated up to 10 Gy (1 krad), additional calibration is needed for measurements beyond this limit.

The on-chip diode is connected between pin 1 (anode) and pin 2 (cathode). The diode is not sensitive to ionizing radiation in the way the RADFETs are. The diode can be used as an indicator of the chip temperature during irradiation (sense mode) only.

During RADFET irradiation (sense mode) the diode can be forward biased by forcing positive current into pin1 and the diode voltage obtained at the same pin. It is recommended that after diode forward bias, pin1 is connected back to the ground or remain floating.

During RADFET read-out mode (accumulated radiation dose read-out) the diode **must not** be forward biased as it will influence the RADFET readout voltage and disturb the measurement.

For diode response over a temperature range, and other queries related to this document please contact support@varadis.com.